

PATENT ASSIGNMENT

Electronic Version v1.1
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| SUBMISSION TYPE: | NEW ASSIGNMENT | | | | | | | | | | |
|---|--|---------------------------------------|---------------------|--|----------------|------------|-------------------|------------|--------------|------------|--|
| NATURE OF CONVEYANCE: | ASSIGNMENT | | | | | | | | | | |
| CONVEYING PARTY DATA | | | | | | | | | | | |
| <table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>Mikio ICHIHASHI</td><td>10/28/2011</td></tr><tr><td>Takashi ONISHI</td><td>10/18/2011</td></tr><tr><td>Shunichi WATANABE</td><td>10/18/2011</td></tr><tr><td>Keiji TAMURA</td><td>10/18/2011</td></tr></tbody></table> | Name | Execution Date | Mikio ICHIHASHI | 10/28/2011 | Takashi ONISHI | 10/18/2011 | Shunichi WATANABE | 10/18/2011 | Keiji TAMURA | 10/18/2011 | |
| Name | Execution Date | | | | | | | | | | |
| Mikio ICHIHASHI | 10/28/2011 | | | | | | | | | | |
| Takashi ONISHI | 10/18/2011 | | | | | | | | | | |
| Shunichi WATANABE | 10/18/2011 | | | | | | | | | | |
| Keiji TAMURA | 10/18/2011 | | | | | | | | | | |
| RECEIVING PARTY DATA | | | | | | | | | | | |
| <table border="1"><tr><td>Name:</td><td>Hitachi High-Technologies Corporation</td></tr><tr><td>Street Address:</td><td>24-14, Nishi Shimbashi 1-chome, Minato-ku,</td></tr><tr><td>City:</td><td>Tokyo</td></tr><tr><td>State/Country:</td><td>JAPAN</td></tr></table> | Name: | Hitachi High-Technologies Corporation | Street Address: | 24-14, Nishi Shimbashi 1-chome, Minato-ku, | City: | Tokyo | State/Country: | JAPAN | | | |
| Name: | Hitachi High-Technologies Corporation | | | | | | | | | | |
| Street Address: | 24-14, Nishi Shimbashi 1-chome, Minato-ku, | | | | | | | | | | |
| City: | Tokyo | | | | | | | | | | |
| State/Country: | JAPAN | | | | | | | | | | |
| PROPERTY NUMBERS Total: 1 | | | | | | | | | | | |
| <table border="1"><thead><tr><th>Property Type</th><th>Number</th></tr></thead><tbody><tr><td>Application Number:</td><td>13322025</td></tr></tbody></table> | Property Type | Number | Application Number: | 13322025 | | | | | | | |
| Property Type | Number | | | | | | | | | | |
| Application Number: | 13322025 | | | | | | | | | | |
| CORRESPONDENCE DATA | | | | | | | | | | | |
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| Email: washington_ip_docket@mwe.com | | | | | | | | | | | |
| <i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via US Mail.</i> | | | | | | | | | | | |
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| ATTORNEY DOCKET NUMBER: | 075905-0142 | | | | | | | | | | |
| NAME OF SUBMITTER: | Keith E. George/ksa | | | | | | | | | | |
| Total Attachments: 2 source=0759050142assigntransmittal#page1.tif source=0759050142assign#page1.tif | | | | | | | | | | | |

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RECORDATION FORM COVER SHEET

Docket No.: 075905-0142

PATENTS ONLY

To the Director of the U. S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.

1. Name of Conveying Party(ies)

**Mikio ICHIHASHI, Takashi ONISHI, Shunichi
WATANABE, Keiji TAMURA**

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

3. Nature of Conveyance/Execution Date(s)

Execution Date(s): **October 28, 2011; October 18, 2011;
October 18, 2011 and October 18, 2011
respectively**

- | | |
|---|---|
| <input checked="" type="checkbox"/> Assignment | <input type="checkbox"/> Merger |
| <input type="checkbox"/> Security Agreement | <input type="checkbox"/> Change of Name |
| <input type="checkbox"/> Joint Research Agreement | |
| <input type="checkbox"/> Government Interest Assignment | |
| <input type="checkbox"/> Executive Order 9424, Confirmatory License | |

2. Name and address of receiving party(ies)

Name: **Hitachi High-Technologies Corporation**

Internal Address:

Address: **24-14, Nishi Shimbashi 1-chome, Minato-ku,
Tokyo, Japan**

4. Application or patent number(s):

A. Patent Application No(s).

☒ This document is being filed together with a new application.

B. Patent No(s).

**5. Name and address to whom correspondence concerning
document should be mailed:**

Name: **MCDERMOTT WILL & EMERY LLP**

Internal Address:

Street Address: **600 13th Street, N.W.**

City: **Washington,** State: **DC** Zip: **20005-3096
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Email Address: **mweipdocket@mwe.com**

**6. Total number of applications and patents
involved:**

7. Total fee (37 CFR 1.21(h) & 3.41) \$40.00

- ☐ Authorized to be charged by credit card
- ☒ Authorized to be charged to deposit account
- ☐ Enclosed
- ☐ None required (government interest not affecting title)

8. Payment Information:

- a. Credit Card Last 4 Numbers _____
Expiration Date _____
- b. Deposit Account Number 500417
Authorized User Name _____

9. Signature.

Keith E. George 34,111



November 22, 2011

Name and Registration No. of Person Signing

Signature

Date

Total number of pages including cover sheet, attachments and documents: **2**

ASSIGNMENT
(譲 渡 証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by Hitachi High-Technologies Corporation, a corporation organized under the laws of Japan, located at 24-14, Nishi Shimbashi 1-chome, Minato-ku, Tokyo, Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said Hitachi High-Technologies Corporation, its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

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invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, No. PCT/JP2010/002684 filed April 14, 2010, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said Hitachi High-Technologies Corporation, its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Hitachi High-Technologies Corporation.

Signed on the date(s) indicated aside our signatures:

INVENTOR(S)
(発明者フルネームサイン)

Date Signed
(署名日)

| | |
|------------------------------|-------------------|
| 1) <u>Mikio Ichihashi</u> | <u>10/28/2011</u> |
| 2) <u>Takashi Onishi</u> | <u>10/18/2011</u> |
| 3) <u>Shun-ichi Watanabe</u> | <u>10/18/2011</u> |
| 4) <u>Keiji Tamura</u> | <u>10/18/2011</u> |
| 5) _____ | _____ |
| 6) _____ | _____ |
| 7) _____ | _____ |
| 8) _____ | _____ |
| 9) _____ | _____ |
| 10) _____ | _____ |